

30V P-Channel MOSFET

Product Summary

V(BR)DSS	R _{DS(on)MAX}	lь
	65mΩ@-10V	
-30V	75mΩ@-4.5V	-4.2A
	90mΩ@-2.5V	

Feature

- TrenchFET Power MOSFET
- Exceptional on-resistance and maximum DC current capability

Application

- DC/DC Converter
- Load Switch for Portable Devices
- Battery Switch

MARKING:



ABSOLUTE MAXIMUM RATINGS (Ta=25°C unless otherwise noted)

207.02
SOT-23
Schematic diagram

Parameter	Symbol	Symbol Value		
Drain-Source Voltage	V _{DS}	-30	V	
Gate-Source Voltage	V _{GS}	±12	V	
Continuous Drain Current	lD	-4.2	A	
Power Dissipation	PD	0.35	W	
Thermal Resistance from Junction to Ambient	Reja	357	°C /W	
Junction Temperature	TJ	150	°C	
Storage Temperature	T _{STG}	-55~ +150	°C	



MOSFET ELECTRICAL CHARACTERISTICS(Ta=25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Туре	Мах	Unit	
Static Characteristics	·		·	·			
Drain-source breakdown voltage	V(BR)DSS	V _{GS} = 0V, I _D =-250µA	-30			V	
Zero gate voltage drain current	I _{DSS}	V _{DS} =-24V,V _{GS} = 0V			-1	μA	
Gate-body leakage current	lgss	Vgs =±12V, Vds = 0V			±100	nA	
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250µA	-0.7	-0.9	-1.3	V	
Drain-source on-resistance ⁽¹⁾		V _{GS} =-10V, I _D =-4.2A		50	65		
	R _{DS(on)}	V _{GS} =-4.5V, I _D =-4A	60 7			mΩ	
		Vgs =-2.5V, Id =-1A		70	90	1	
Forward tranconductance ⁽¹⁾	g fs	VDS =-5V, ID =-4.2A		10		S	
Dynamic characteristics ⁽²⁾	·		·				
Input Capacitance	Ciss			954			
Output Capacitance	Coss	V _{DS} =-15V,V _{GS} =0V,f =1MHz		115		pF	
Reverse Transfer Capacitance	Crss			77			
Switching characteristics ⁽²⁾			·				
Turn-on delay time	t _{d(on)}				6.3		
Turn-on rise time	tr	Vgs=-10V,Vds=-15V,			3.2		
Turn-off delay time	t _{d(off)}	RL=3.6Ω,R _{GEN} =6Ω			38.2	ns	
Turn-off fall time	t _f	-			12		
Source-Drain Diode characteristics	j						
Diode forward current	ls				-2	А	
Diode pulsed forward current	I _{SM}				-25	А	
Diode Forward voltage(1)	V _{DS}	V _{GS} =0V, I _S =-4.2A			-1.2	V	

Notes:

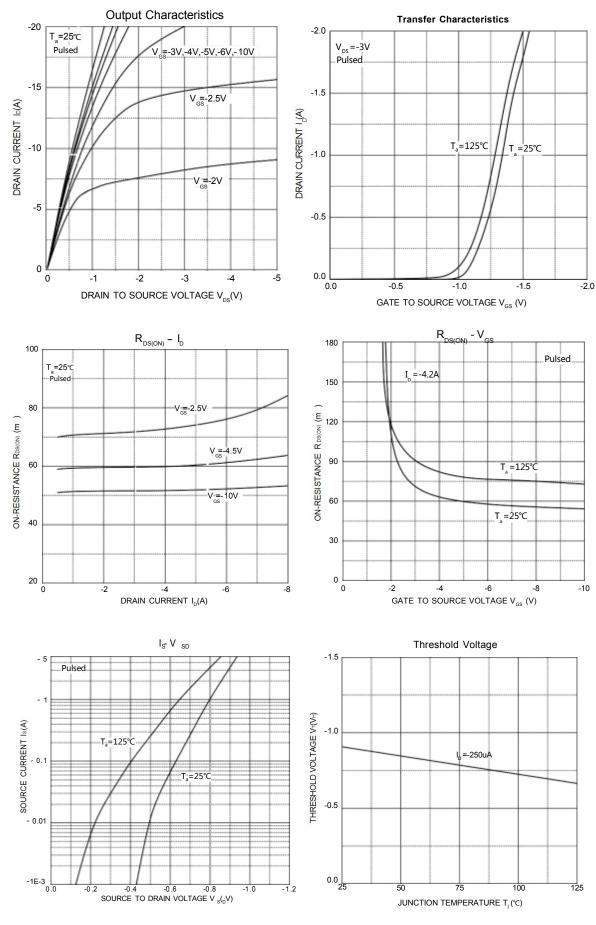
1. Pulse test; pulse width≤300µs, duty cycle≤2%.

2. Guaranteed by design, not subject to production testing.

RS3401E

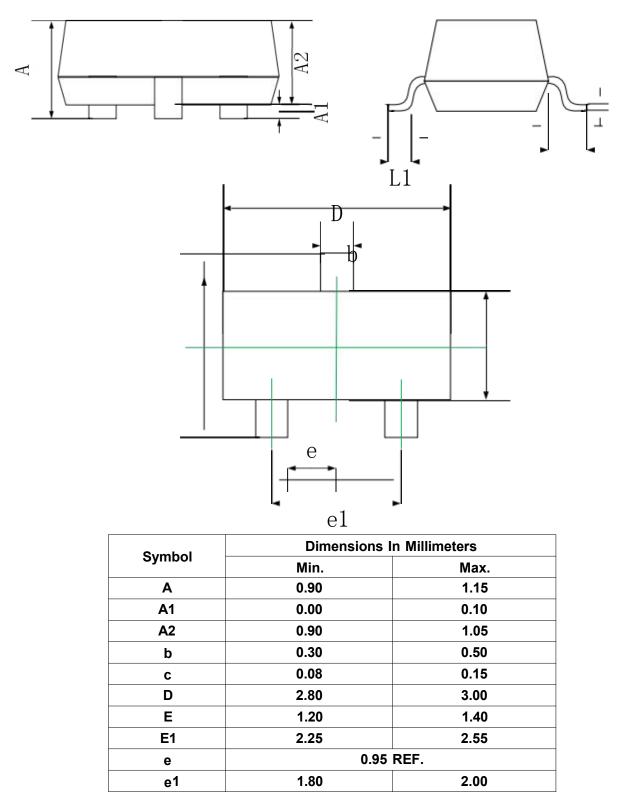


Typical Electrical and Thermal Characteristics





SOT-23 Package Information



L L1 0.55 REF.

0.50

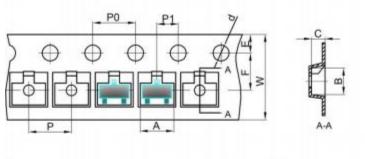
0.30



SOT-23 Tape and Reel

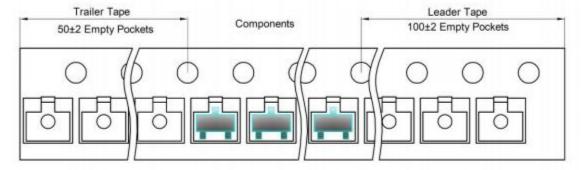
SOT-23 Tape and reel

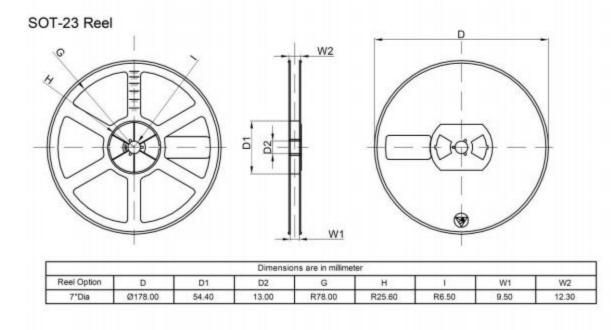
SOT-23 Embossed Carrier Tape



Dimensions are in milimeter										
Pkg type	A	В	С	d	E	F	P0	Р	P1	W
SOT-23	3.15	2.77	1.22	Ø1.50	1.75	3.50	4.00	4.00	2.00	8.00

SOT-23 Tape Leader and Trailer





REEL	Reel Size	Box	Box Size(mm)	Carton	Carton Size(mm)	G.W.(kg)
3000 pcs	7 inch	30,000 pcs	203×203×195	120,000 pcs	438×438×220	

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